APPROVAL SHEET

WF12Q/R_S, WF08Q/R_S, WF06Q/R_S
WF04T/U_S

±1%, ±0.5%, ±0.25%, ±0.1%,

TC50, TC25

Thin Film Pulse Withstanding Chip Resistors
(RoHS compliant、Halogen Free)
Size 1206, 0805, 0603, 0402

*Contents in this sheet are subject to change without prior notice.

FEATURE

1. SMD metal thin film resistor
2. High reliability and stability of 0.5% and below per customer request
3. High performance of TCR: 50 & 25 ppm/°C and below per customer request
4. Low current noise
5. RoHS compliant and lead free
6. Sulfuration resistant against ASTM B-809-95
7. Low resistance with superior pulse withstand ability
8. Meet the requirements of standards of specifications as IEC 60115-1 4.24.2, test 96 hours at 85℃/85%RH.
9. Meet the requirements of Q/GDW 11179.3-2014 Class C, 10ms application of a voltage 10 times RCWV

APPLICATION

- Test equipment
- Measuring instrument
- E-meter
- Smart meter
- Advanced Metering Infrastructure

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive layer that is applied to the top surface of the substrate. The composition of the resistive layer is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For environmental soldering issue, the outer layer of these end terminations is a Lead-free solder .

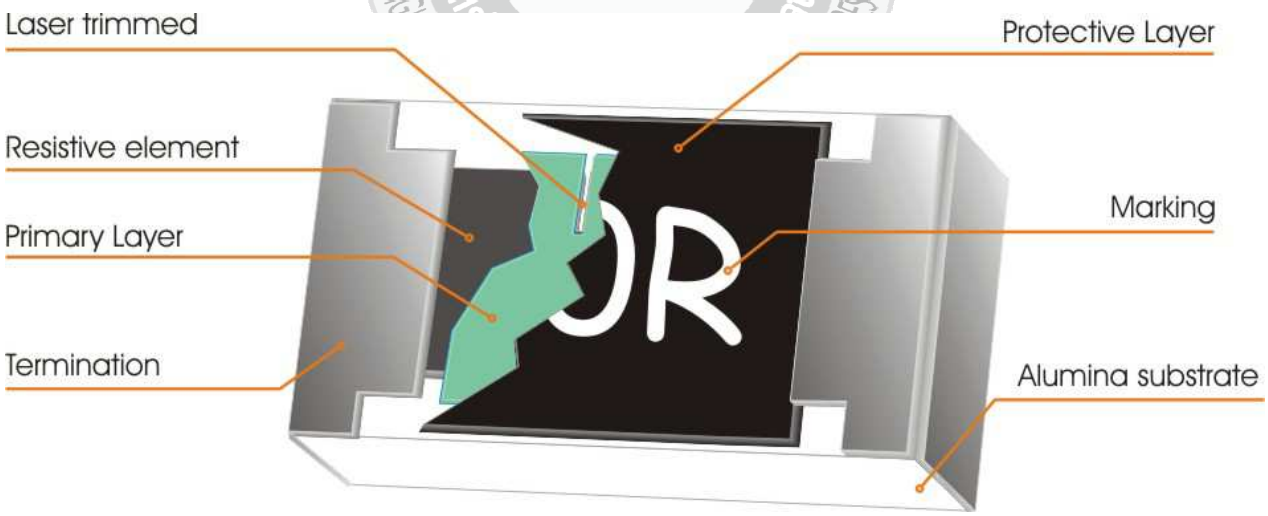


Fig 1. Construction of Chip-R WFxx_S

Item	General Specification			
Series No.	WF12 Q/R_S	WF08 Q/R_S	WF06 Q/R_S	WF04 T/U_S
Size Code	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)
Resistance Tolerance	±1.0%, ±0.5%, ±0.25%, ±0.1%			
Resistance Range	1Ω ~ 30Ω	1Ω ~ 20Ω	1Ω ~ 20Ω	1Ω ~ 20Ω
TCR (ppm/°C)	±50 ppm/°C/ ±25 ppm/°C		±25 ppm/°C : 4.7Ω~20Ω ±50 ppm/°C : 1Ω ~ 20Ω	±25 ppm/°C : 4.7Ω~20Ω ±50 ppm/°C : 1Ω ~ 20Ω
Max. Dissipation at T_{amb}=70°C	1/4W	1/8W	1/10W	1/16W
Max. Operating Voltage	200V	150V	75V	25V
Max. Overload Voltage	400V	300V	150V	50V
Operating Temperature	- 55~ +155°C			

QUICK REFERENCE DATA

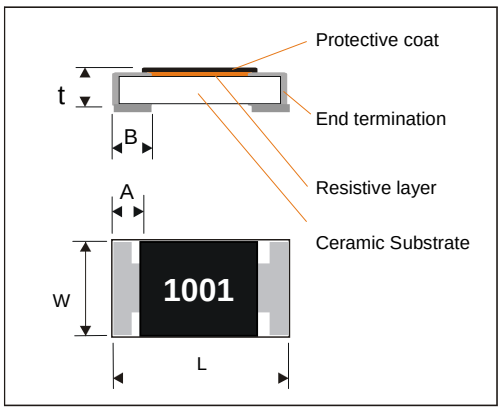
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

   $RCWV = \sqrt{Rated\,Power \times Resistance\,Value}$ or Max. RCWV listed above, whichever is lower.
3. 1Ω ~ 20Ω for 0603/0402 : TCR ±25 ppm/°C is upon request.

DIMENSIONS :(unit:mm)

Type	WF12Q/R_S	WF08Q/R_S	WF06Q/R_S	WF04T/U_S
L	3.05 ± 0.15	2.00 ± 0.10	1.55 ± 0.10	1.00 ± 0.10
W	1.55 ± 0.15	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
A	0.40 ± 0.20	0.25 ± 0.20	0.25 ± 0.15	0.30 ± 0.15
B	0.40 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.30 ± 0.15
t	0.55 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.35 ± 0.05



MARKING

- ***3-digits marking for 0603 size***

WFxx_S has same marking rule as WRxx ±1%.

Nominal resistance	Description
1.E-24 series	As *0603 WR06X* ±5%.
2.E-96 series	The 1st two digit codes are referring to the CODE on the table, the 3rd code is the index of resistance value : $Y=10^{-2}$, $X=10^{-1}$, $A=10^{0}$, $B=10^{1}$, $C=10^{2}$, $D=10^{3}$, $E=10^{4}$, $F=10^{5}$ EX : 17.8Ω=25X , 178Ω=25A , 1K78 =25B 17K8=25C , 178K=25D , 1M78=25E
3. Remark	There is no marking for the items are not under E-24 and E-96 series

CODE	R_value	CODE	R_value	CODE	R_Value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value
01	**100**	13	**133**	25	**178**	37	**237**	49	**316**	61	**422**	73	**562**	85	**750**
02	**102**	14	**137**	26	**182**	38	**243**	50	**324**	62	**432**	74	**576**	86	**768**
03	**105**	15	**140**	27	**187**	39	**249**	51	**332**	63	**442**	75	**590**	87	**787**
04	**107**	16	**143**	28	**191**	40	**255**	52	**340**	64	**453**	76	**604**	88	**806**
05	**110**	17	**147**	29	**196**	41	**261**	53	**348**	65	**464**	77	**619**	89	**825**
06	**113**	18	**150**	30	**200**	42	**267**	54	**357**	66	**475**	78	**634**	90	**845**
07	**115**	19	**154**	31	**205**	43	**274**	55	**365**	67	**487**	79	**649**	91	**866**
08	**118**	20	**158**	32	**210**	44	**280**	56	**374**	68	**499**	80	**665**	92	**887**
09	**121**	21	**162**	33	**215**	45	**287**	57	**383**	69	**511**	81	**681**	93	**909**
10	**124**	22	**165**	34	**221**	46	**294**	58	**392**	70	**523**	82	**698**	94	**931**
11	**127**	23	**169**	35	**226**	47	**301**	59	**402**	71	**536**	83	**715**	95	**953**
12	**130**	24	**174**	36	**232**	48	**309**	60	**412**	72	**549**	84	**732**	96	**976**

- ***4-digits marking for 1206, 0805 size***

For E24+E96, each resistor is marked with a four digits code on the protective coating to designate the nominal resistance value. For values below 97Ω6 the R is used as a digit. For values of 100Ω or greater, the first 3 digits are significant; the fourth digit indicates the number of multiple to follow.

Example

RESISTANCE	10Ω	12Ω	100Ω	6800Ω	47000Ω
4-digits marking	10R0	12R0	1000	6801	4702

- ***No marking code for 0402 size***

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E192 & E24 series for resistors with a tolerance of ±1.0%, ±0.5%, ±0.25%, ±0.1%. The values of the E24/E192 series are in accordance with “IEC publication 60063”.

Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

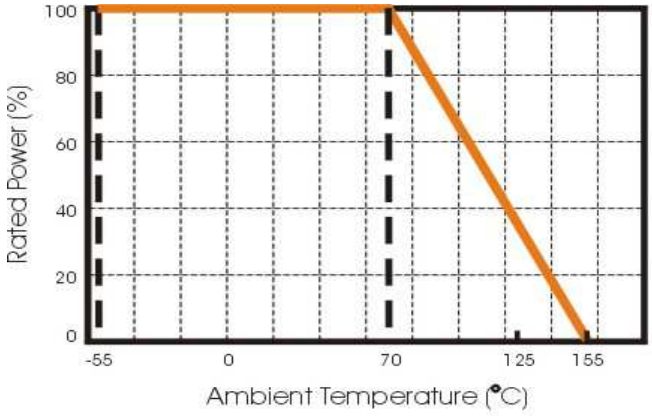


Fig.2 Maximum dissipation in percentage of rated power
As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 245°C during 5 seconds within lead-free solder bath. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering profile and condition that provide reliable joints without any damage are given in Fig 3. and Table 1.

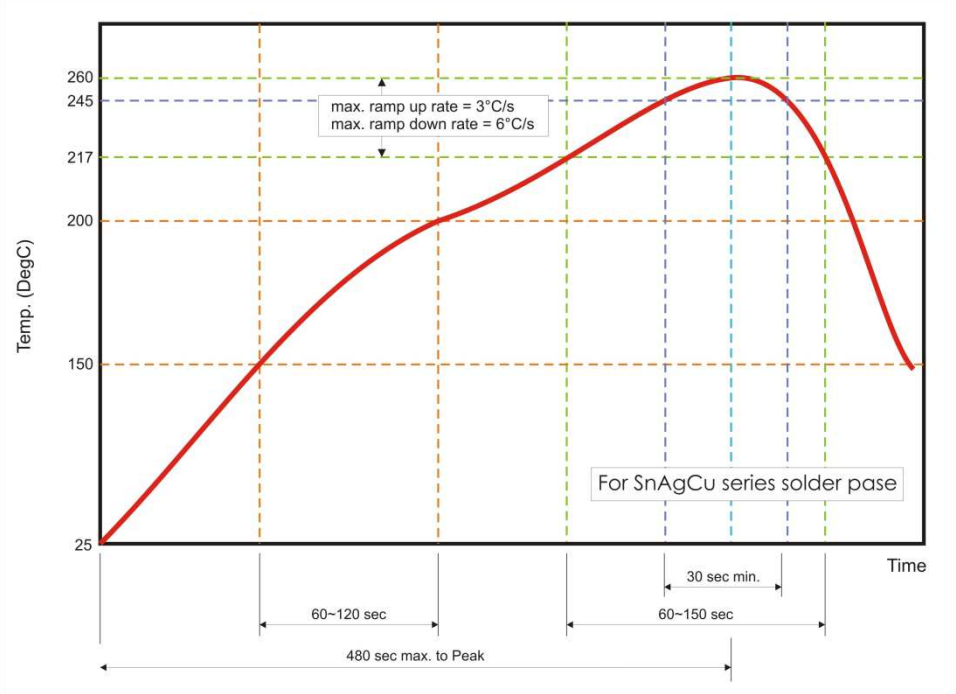


Fig. 3 Infrared soldering profile for Chip Resistors

Table 1. Infrared soldering condition for Chip Resistors

Temperature Condition	Exposure Time
Average ramp-up rate (217°C to 260°C)	Less than 3°C/second
Between 150 and 200°C	Between 60-120 seconds
> 217°C	Between 60-150 seconds
Peak Temperature	260ºC +0/-5°C
Time within 245°C	Min. 30 seconds
Ramp-down rate (Peak to 217°C)	Less than 6°C/second
Time from 25°C to Peak	No greater than 480 seconds

CATALOGUE NUMBERS

The resistors have a catalogue number starting with.

WF06	Q/R	xxxx	B	T	L	S
Size code WF12: 1206 WF08: 0805 WF06: 0603 WF04: 0402	**Type code** Q: TCR = 25 ppm R: TCR = 25 ppm High Power T: TCR = 25 ppm U: TCR = 25 ppm Normal Power	**Resistance code** 220Ω=2200 20Ω =20R0 4.7Ω =4R70	**Tolerance** B : ±0.10% C : ±0.25% D : ±0.50% F : ±1.00%	**Packaging code** T : 7” Reel taping	**Termination code** L = lead free	**Special code** S :Pulse withstanding

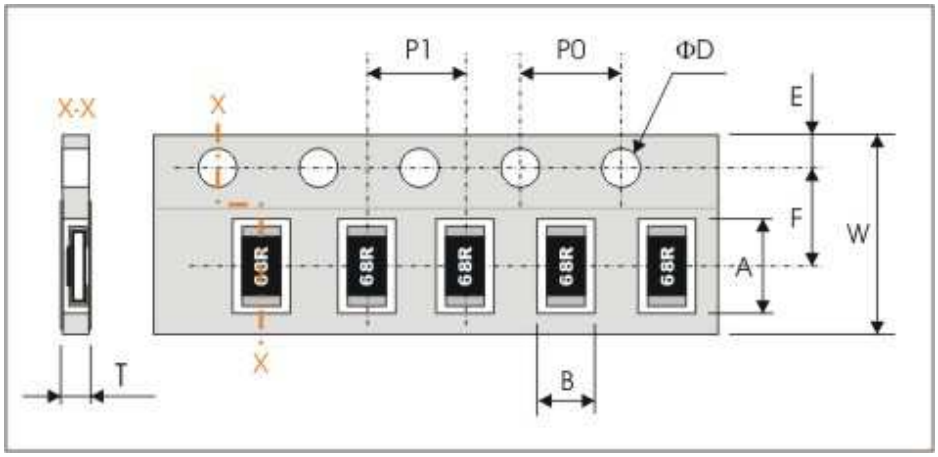
1. Reeled tape packaging: 8mm width paper taping.
   5,000pcs/reel for WF12_S, WF08_S, WF06_S,
   10,000pcs/reel for WF04_S;

TEST AND REQUIREMENTS

TEST	PROCEDURE	REQUIREMENT
		Resistor
DC resistance **IEC60115-1 4.5.1**	DC resistance values measured	Within the specified tolerance
Temperature Coefficient of Resistance(T.C.R) **IEC 60115-1 4.8.4.1**	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6$ (ppm/°C) R_1 : Resistance at reference temperature R_2 : Resistance at test temperature t_1 : 20℃+5℃-1℃ t2 : 125℃+5℃-1℃	Refer to " QUICK REFERENCE DATA "
Short time overload (S.T.O.L) **IEC60115-1 4.13**	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less. Measure test conclusion after 30mins	ΔR/R max. ±(0.5%+0.05Ω)
Resistance to soldering heat(R.S.H) **IEC 60115-1 4.18**	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260℃±5°C	no visible damage Δ R/R max. ±(0.2%+0.05Ω)
Solderability **IEC 60115-1 4.17**	1.Un-mounted chips completely immersed for 5 seconds in a SAC solder bath at 245℃±5℃	good tinning (>95% covered) no visible damage
Temperature cycling **IEC 60115-1 4.19**	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃, 30 minutes at +155 °C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 5 continuous cycles	no visible damage ΔR/R max. ±(0.5%+0.05Ω)
Load life (endurance) **IEC 60115-1 4.25.1**	70±2°C, 1000 hours, loaded with RCWV or Vmax,1.5 hours on and 0.5 hours off	ΔR/R max. ±(0.5%+0.05Ω)
Load life in Humidity **IEC 60115-1 4.24.2**	1000 hours, at rated continuous working voltage in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	ΔR/R max. ±(0.5%+0.05Ω)
Bending strength **IEC 60115-1 4.33**	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 3 mm, once for 10 seconds.	ΔR/R max. ±(0.1%+0.05Ω)
Adhesion **IEC 60115-1 4.32**	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations.
Insulation Resistance **Clause 4.6**	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ
Dielectric Withstand Voltage **Clause 4.7**	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover
Flower of Sulfur **ASTM-B-809-95**	Sulfur 480 hours, 60°C, unpowered	ΔR/R max. ±(1%+0.05Ω)

PACKAGING

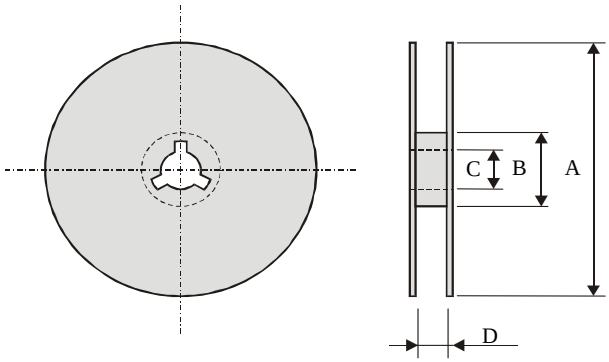
Paper Tape specifications (unit :mm)



Series No.	Tape	A	B	W	D	E
WF12	Paper	3.60±0.20	2.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10
WF08	Paper	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.20	1.75±0.10
WF06	Paper	1.90±0.20	1.10±0.20	8.00±0.30	3.50±0.20	1.75±0.10
WF04	Paper	1.20±0.10	0.7±0.10	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	F	P0	ΦD	T
WF12	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	Max. 1.0
WF08	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	Max. 1.0
WF06	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	0.65±0.05
WF04	2.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	0.40±0.05

Reel dimensions



WF12_S, WF08_S, WF06_S, WF04_S

Symbol	A	B	C	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5

Taping quantity

- Chip resistors 5,000 pcs per reel (WF12_S, WF08_S, WF06_S)
- Chip resistors 10,000 pcs per reel (WF04_S)
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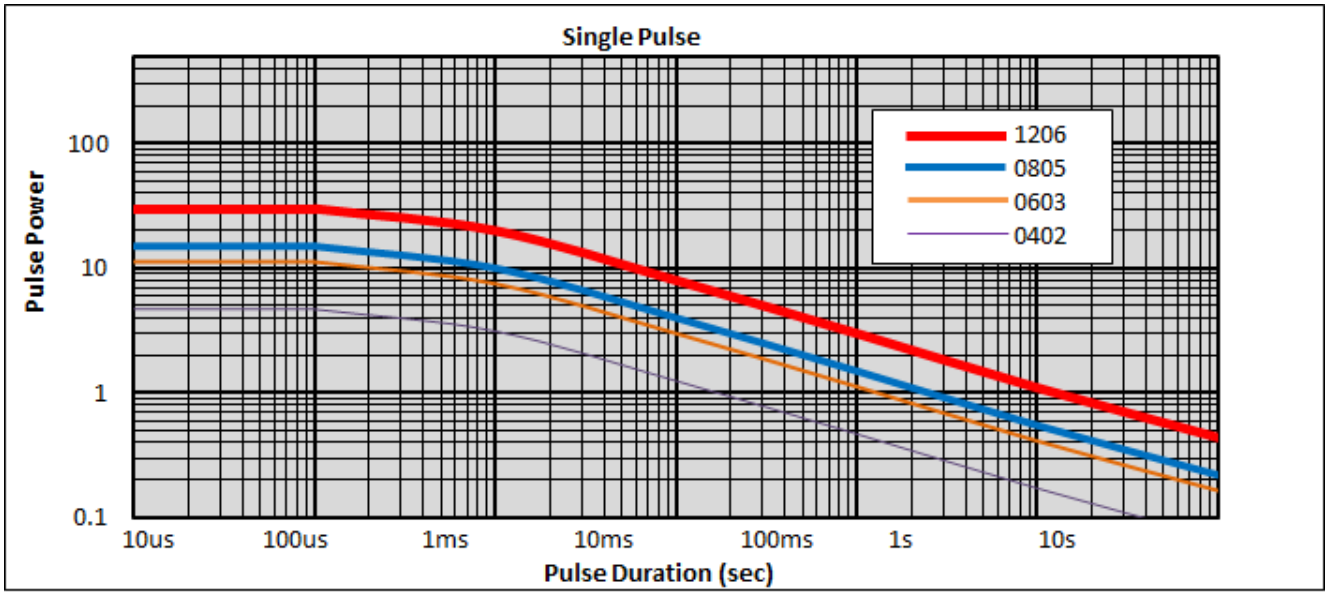
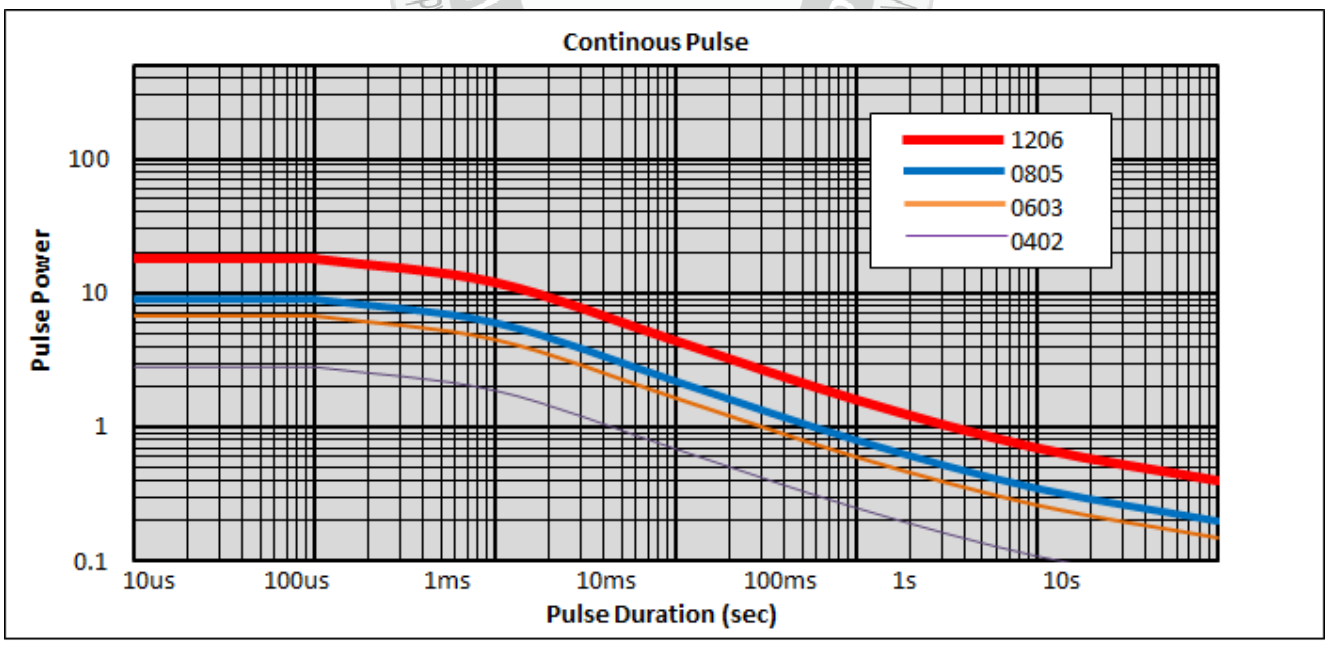
PULSE LOAD PERFORMANCE:

Single Pulse



1,000 rectangular pulse amplitudes are applied to the component at intervals of 60seconds,
Permissible resistance to be varied by ± (0.5% R + 0.05Ω).

Continuous Pulse



Continuous load is a pulse period generated by the repetitive rectangular pulse amplitude,
the applied power dissipation is at a rated power of 70 ° C.
Permissible resistance to be varied by ± (0.5% R + 0.05Ω).